ML9472

Static,1/2Duty 60 Output LCD Driver

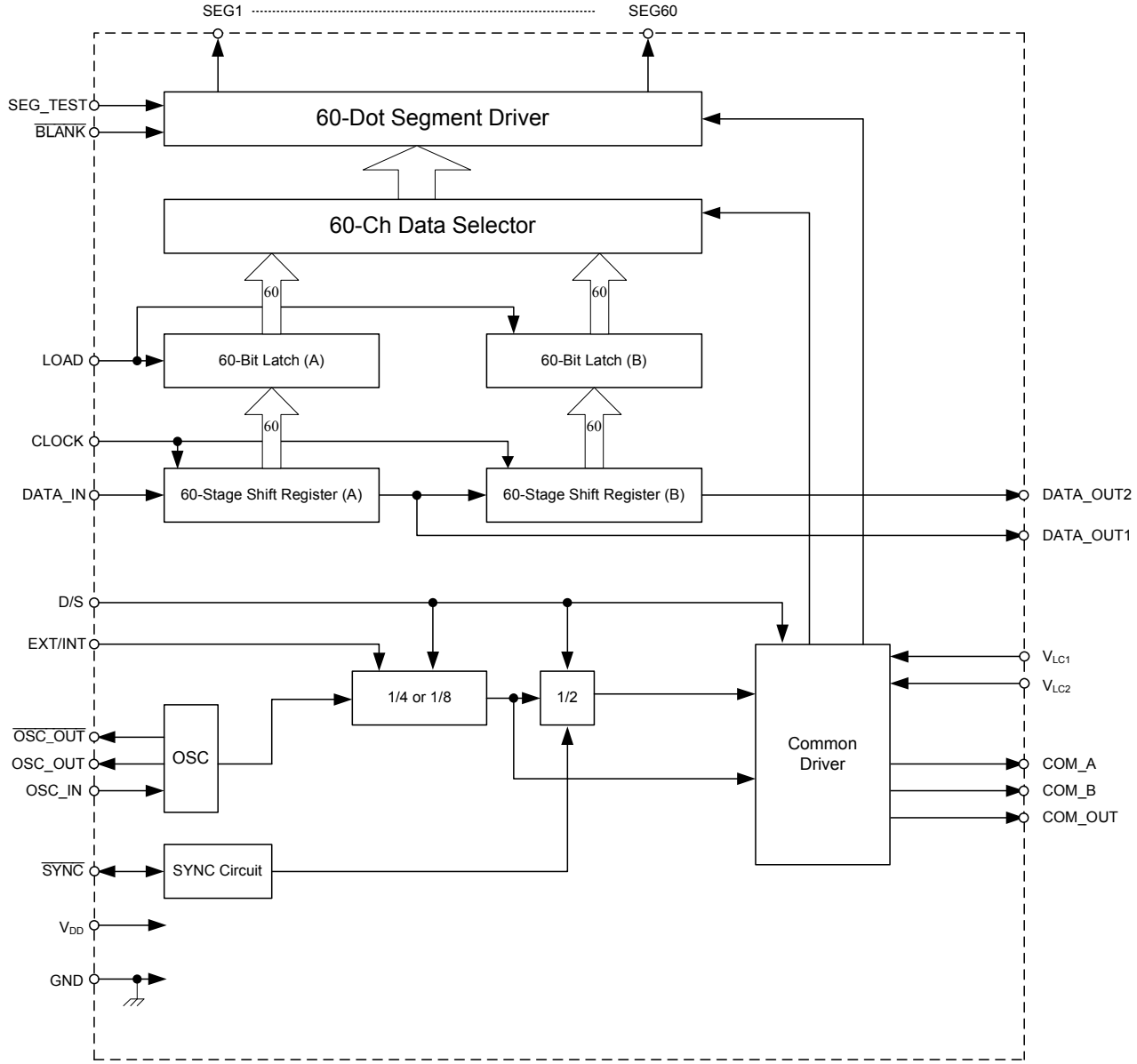
GENERAL DESCRIPTION

The ML9472 is a LCD driver which can directly drive up to 60 segments in the static display mode and up to 120 segments in the 1/2 duty dynamic display mode.

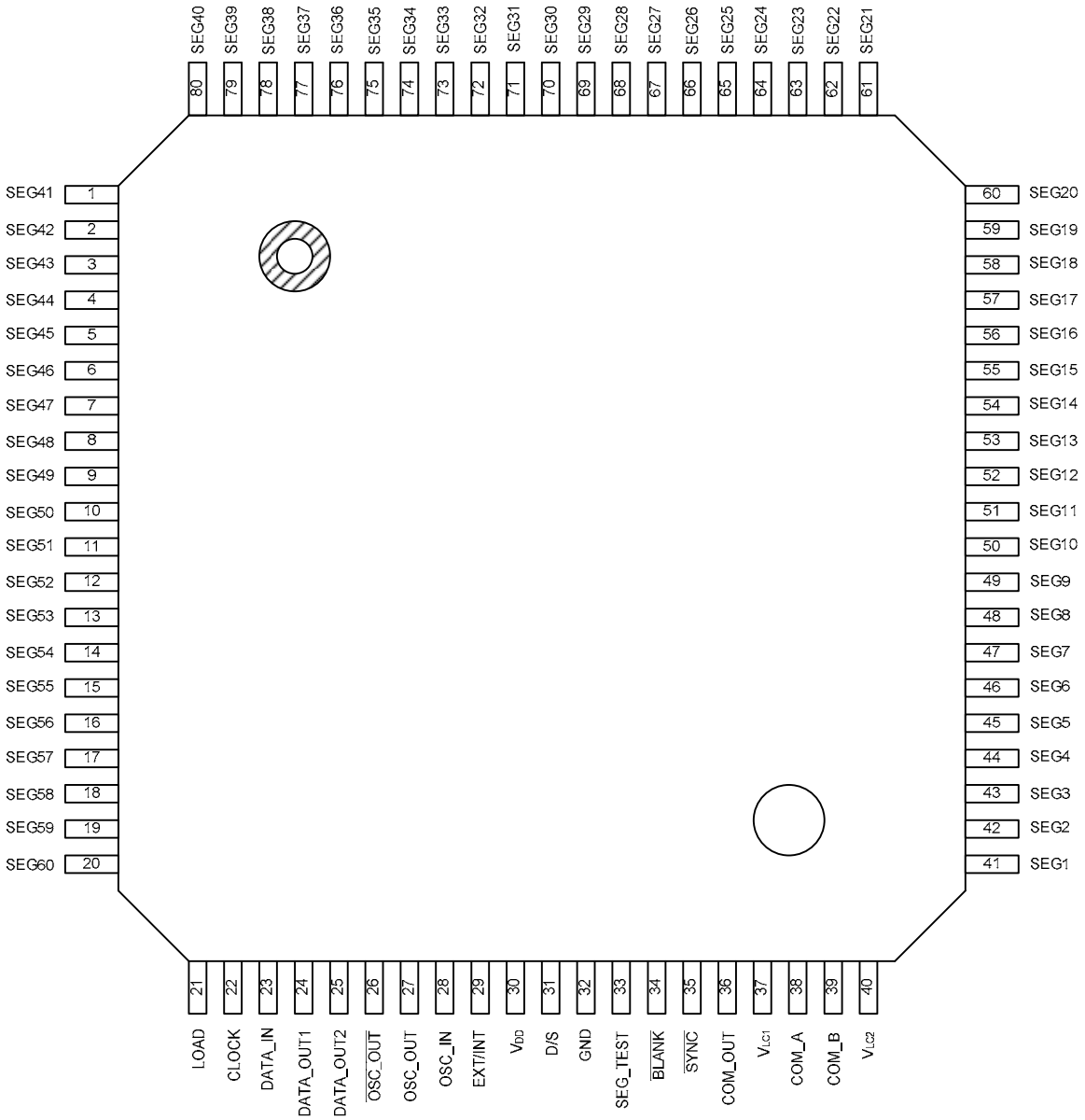
FEATURES

- Operating range
  - Supply voltage : 3.0 to 5.5 V
  - Operating temperature range : –40 to + 105°C
- Segment output
  - Static display mode : Up to 60 segments can be displayed.
  - 1/2 duty : Up to 120 segments can be displayed.
- Simple interface with microcomputer
- Built-in common signal generator
- One-to-one correspondence between input data and output data
  - When input data is at “H” level : Display goes on.
  - When input data is at “L” level : Display goes off.
- Test pin for all-on (SEG_TEST) and all-off ($\overline{\text{BLANK}}$)
- Can be cascade-connected
- Can be synchronized with the external common signal
- Applicable as an output expander
- Package
  - 80-pin plastic TQFP (TQFP80-P-1212-0.50-K) (Product name: ML9472TB)

BLOCK DIAGRAM



PIN CONFIGURATION (TOP VIEW)



80-Pin Plastic TQFP

PIN DESCRIPTION

Symbol	Type	Description
OSC_IN OSC_OUT $\overline{\text{OSC\_OUT}}$	I O O	Pins for oscillation. The oscillator circuit is configured by externally connecting two resistors and a capacitor. Make the wiring length as short as possible, because the resistor connected to the OSC_IN pin has a higher value and the circuit is susceptible to external noise.
DATA_IN	I	Serial data input pin. The display goes on when input data is at a "H" level, and it goes off when input data is at a "L" level.
CLOCK	I	Shift clock input pin. Data from the DATA pin is transferred in synchronization with the rising edge of the shift clock.
LOAD	I	Load signal input pin. Serially input data is transferred to the 60-bit latch at a "H" level of this load signal, then held at a "L" level.
$\overline{\text{BLANK}}$	I	Input pin that turns off all segments. The entire display goes off when a "L" level is applied to this pin. The display returns to the previous state when a "H" level is applied. When SEG_TEST pin is at a "H" level, the input on this pin is disabled.
SEG_TEST	I	Input pin is used to test the segment outputs (SEG_1 to SEG_{60}). All displays are turned on when "H" is applied to this pin. The display returns to the previous state when a "L" level is applied. When this pin is at a "H" level, the input on the $\overline{\text{BLANK}}$ pin is disabled.
D/S	I	When "H" is applied to this pin, the ML9472 operates in the 1/2 duty dynamic display mode. When this pin is set at a "L" level, the ML9472 operates in the static display mode.
EXT/INT	I	When the external common signal is used, fix this pin at a "H" level and input the external common signal from the OSC_IN pin. The input common signal is used as the internal common signal and is output from the COM_OUT pin through the buffer. When the built-in common signal generator is used, fix this pin at a "L" level. When the ML9472 is used as an output expander, fix this pin at a "H" level and the OSC_IN pin at a "L" level. The output logic can be reversed with respect to the input data by setting OSC_IN to a "H" level.
$\overline{\text{SYNC}}$	I/O	This pin is an input/output pin which is used when two or more ML9472s are connected in series (cascade connection) in the 1/2 duty dynamic display mode. All of the involved ML9472's $\overline{\text{SYNC}}$ pins should be connected by the common line and they should be pulled up with a common resistor, which makes a phase level of all involved ML9472's COM_A and COM_B pins equal. When a single ML9472 is used in the dynamic display mode, $\overline{\text{SYNC}}$ should be pulled up with a resistor. Connect this pin to GND if any of the following conditions is true: - The ML9472 is operated in the static display mode. - The ML9472 is used as an output expander.
DATA_OUT1	O	The 60^{th} stage data of the shift register is output from this pin. When two or more ML9472s are connected in series (cascade connection) in the static display mode, this pin should be connected to the next ML9472's DATA_IN Pin.
DATA_OUT2	O	The 120^{th} stage data of the shift register is output from this pin. When two or more ML9472s are connected in series (cascade connection) in the 1/2 duty dynamic display mode, this pin should be connected to the next ML9472's DATA_IN pin.
COM_OUT	O	When tow or more ML9472s are connected in series (cascade connection), this pin should be connected with all of the slave ML9472's OSC_IN pins.

Symbol	Type	Description
COM_A COM_B	O O	LCD driving common signals is output from these pins. These pins should be connected to the COMMON side of the LCD panel. - In the static display mode A pulse in phase with the COM_OUT is output from both COM_A and COM_B. In this case, the high level is V_{DD}, and the low level is V_{LC2}. - In the 1/2 duty dynamic display mode The COM_A and COM_B output signals are alternately changed within each COM_OUT output cycle, resulting in alternate repetition of select and non-select modes.
SEG1 to SEG60	O	Display output pins for LCD. Theses pins are connected to the SEGMENT side of the LCD panel. For the correspondence between the output of these pins and input data, see Section, “Data Structure”.
V_{LC1}, V_{LC2}	—	Bias pins for LCD driver. Through these pins, bias voltages for the LCD are externally supplied. In the static display mode, V_{LC1} should be open. $V_{LC1} = V_{DD} /2$ $V_{DD} > V_{LC1} > V_{LC2} = GND$
V_{DD}, GND	—	Supply voltage pin and ground pin.

Note: Built-in schmitt circuit is used for all input pins.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Rating	Unit
Supply Voltage	V_{DD}	Ta = 25°C	–0.3 to 6.5	V
Input Voltage	V_I	Ta = 25°C	–0.3 to V_{DD}+0.3	V
Storage Temperature	T_{STG}	—	–55 to 150	°C
Power Dissipation	P_D	Ta < 105°C	650	mW
Output Current	I_{O1}	Driver Outputs	–2.0 to 2.0	mA
	I_{O2}	Logic Outputs	–2.0 to 2.0	mA

RECOMMENDED OPERATING CONDITIONS

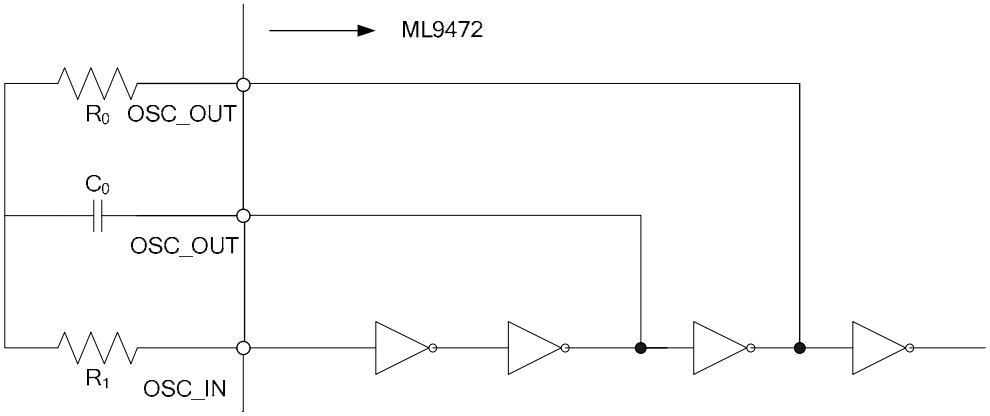
Parameter	Symbol	Condition	Range	Unit
Supply Voltage	V_{DD}	—	3 to 5.5	V
LCD Driving Voltage	V_{LCD}	V_{DD} - V_{LC2}	3 to V_{DD}	V
CLOCK Frequency	f_{CP}	—	0.3 to 4	MHz
Operating Temperature	Ta	—	–40 to 105	°C

OSCILLATOR CIRCUIT

Parameter	Symbol	Applicable pin	Condition	Min.	Typ.	Max.	Unit
Oscillator Resistance	R_0	$\overline{OSC\_OUT}$	—	56	100	220	kΩ
Oscillator Capacitance	C_0	OSC_OUT	Film capacitor	0.001	—	0.047	μF
Current Limiting Resistance	R_1	OSC_IN	$R_1 \geq 10R_0$	560	1000	2220	kΩ
Common Signal Frequency	f_{COM}	COM_A COM_B	—	25	—	150	Hz

Note: See Section, “Reference Data”, for the resistor and capacitor values in the table.

Example of an oscillator circuit:



ELECTRICAL CHARACTERISTICS

DC Characteristics

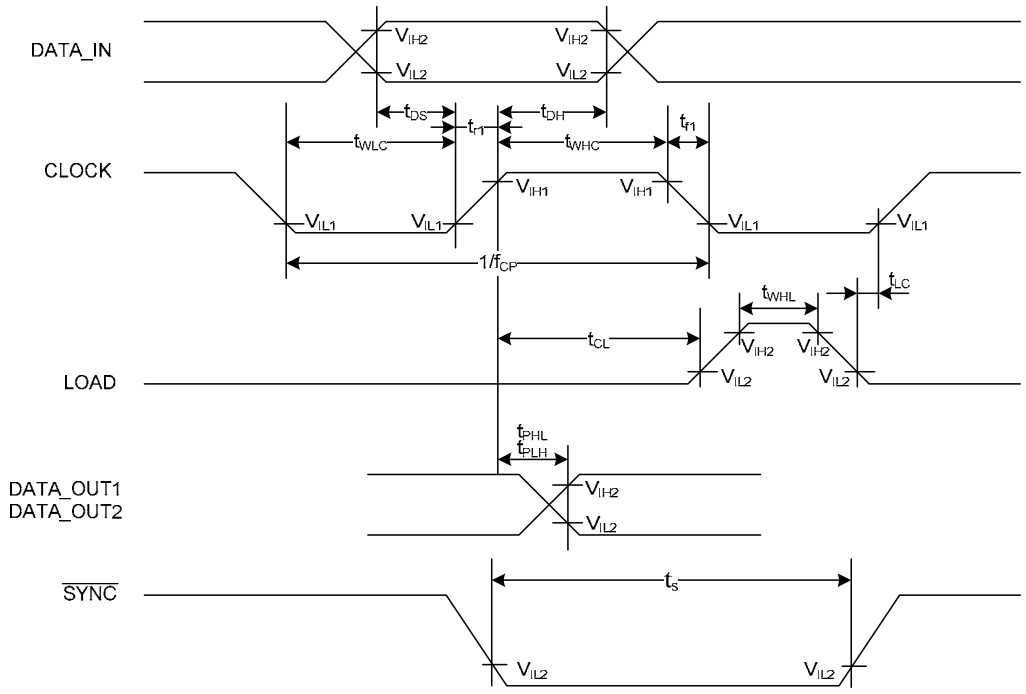
(V_{DD} = 3.0 to 5.5 V, Ta = –40 to +105°C, unless otherwise specified)

Parameter	Symbol	Applicable pin	Condition	Min.	Max.	Unit
"H" Input Voltage	V_{IH}	SEG_TEST, $\overline{\text{BLANK}}$, LOAD, DATA_IN, CLOCK, D/S, EXT/INT, OSC_IN	—	0.8 V_{DD}	V_{DD}	V
"L" Input Voltage	V_{IL}		—	GND	0.2 V_{DD}	V
"H" Input Current	I_{IH}		V_I = V_{DD}	—	1	µA
"L" Input Current	I_{IL}		V_I = 0 V	–1	—	µA
"H" Output Voltage	V_{OH1}	DATA_OUT1 DATA_OUT2 COM_OUT	I_O = –100 µA, V_{DD} = 5.0 V	4.5	—	V
	V_{OH2}	OSC_OUT $\overline{\text{OSC\_OUT}}$	I_O = –200 µA, V_{DD} = 5.0 V	4.5	—	V
"L" Output Voltage	V_{OL1}	DATA_OUT1 DATA_OUT2 COM_OUT	I_O = 100 µA, V_{DD} = 5.0 V	—	0.5	V
	V_{OL2}	OSC_OUT $\overline{\text{OSC\_OUT}}$	I_O = 200 µA, V_{DD} = 5.0V	—	0.5	V
	V_{OL3}	$\overline{\text{SYNC}}$	I_O = 250 µA, V_{DD} = 5.0 V	—	0.8	V
COMMON Output Voltage	V_{OCH}	COM_A COM_B	V_{DD} = 5.0 V, V_{LC1} = 2.5 V, V_{LC2} = 0 V, I_O = –150 µA	4.8	—	V
	V_{OCM}	COM_A COM_B	V_{DD} = 5.0 V, V_{LC1} = 2.5 V, V_{LC2} = 0 V, I_O = ±150 µA	2.3	2.7	V
	V_{OCL}	COM_A COM_B	V_{DD} = 5.0 V, V_{LC1} = 2.5 V, V_{LC2} = 0 V, I_O = 150 µA	—	0.2	V
Segment Output Voltage	V_{OSH}	SEG_1 - SEG_{60}	V_{DD} = 5.0 V, V_{LC1} = 2.5 V, V_{LC2} =0 V; I_O = –30 µA	4.8	—	V
	V_{OSL}		V_{DD} = 5.0 V, V_{LC1} = 2.5 V, V_{LC2} =0 V; I_O = +30 µA	—	0.2	V
Output Leakage Current	I_{LO}	$\overline{\text{SYNC}}$	V_{DD} = 5.0 V and V_O = 5 V when internal Tr is off	—	5	µA
Segment Output Impedance	R_{SEG}	SEG_1 – SEG_{60}	V_{DD} = 5.0 V, V_{LC1} = 2.5V, V_{LC2} = 0V	—	10	kΩ
Common Output Impedance	R_{COM}	COM_A COM_B	V_{DD} = 5.0 V, V_{LC1} = 2.5V, V_{LC2} = 0V	—	1.5	kΩ
Static Supply Current	I_{DD1}	V_{DD}	Fix all input levels at either V_{DD} or GND	—	100	µA
Dynamic Supply Current	I_{DD2}	V_{DD}	V_{DD} = 5.0V, No load. R_0 = 100 kΩ, C_0 = 0.01 µF, R_1 = 1 MΩ	—	0.5	mA

AC Characteristics

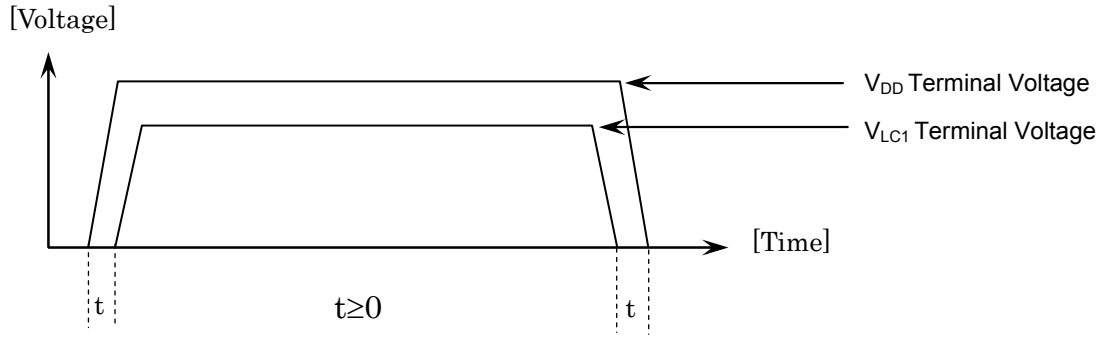
(V_{DD} = 3 to 5.5 V, Ta = −40 to +105°C, unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Clock “H” Time	t_{WHC}	—	70	—	—	ns
Clock “L” Time	t_{WLC}	—	70	—	—	ns
Data Set-up Time	t_{DS}	—	50	—	—	ns
Data Hold Time	t_{DH}	—	50	—	—	ns
Load “H” Time	t_{WHL}	—	100	—	—	ns
Clock-to-load Time	t_{CL}	—	100	—	—	ns
Load-to-Clock Time	t_{LC}	—	100	—	—	ns
“H”, “L” Propagation Delay Time	t_{PHL} t_{PLH}	Load capacitance of DATA_OUT1, DATA_OUT2: 15 pF	—	—	0.14	µs
Clock Rise time, Fall time	t_{r1}, t_{f1}	—	—	—	50	ns
$\overline{SYNC}$ Pulse “L” Time	t_S	—	0.2	—	—	µs
OSC_IN Input Frequency	f_{OSC}	—	—	—	5	kHz



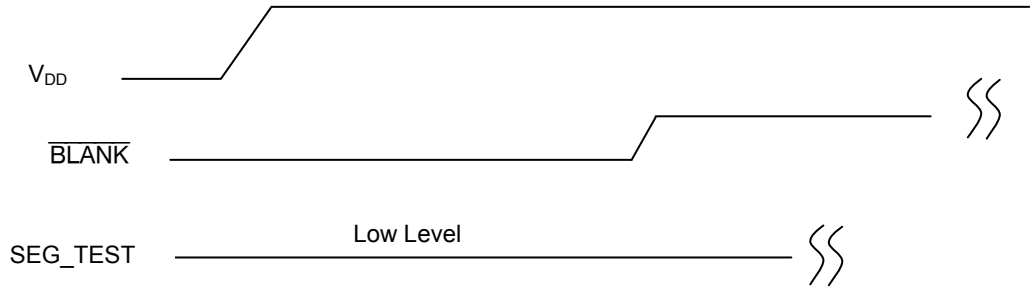
(V_{IH} = 0.8V_{DD} V_{IL} = 0.2V_{DD})

POWER-ON/OFF TIMING



* Please start up V_{LC1} after turning on the V_{DD} power supply. Or, please start up at the same time.

INITIAL SIGNAL TIMING

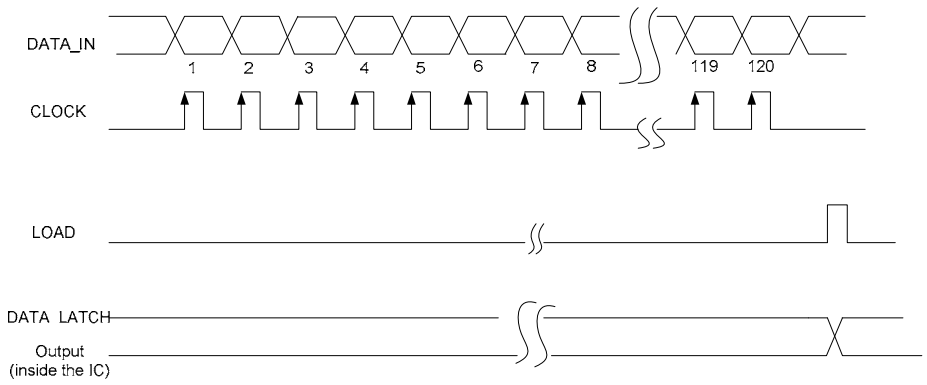


* After VDD is applied, $\overline{BLANK}$ and SEG_TEST should be applied to 'L' level to make all SEGMENTS off until first group of display data is latched.

FUNCTIONAL DESCRIPTION

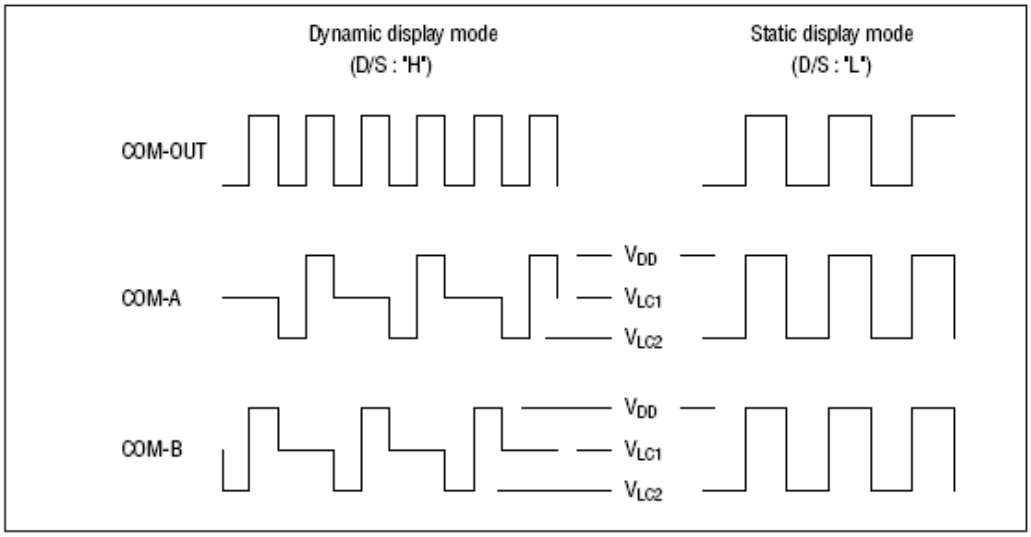
Operation Description

The ML9472 consists of a 120-stage shift register, 120-bit data latch, and 60 pairs of LCD drivers. The display data is input from the DATA_IN pin to the 120-stage shift register at the rising edge of the CLOCK pulse and it is shifted to the 120-bit data latch when the LOAD signal is set at "H" level, then it is directly output from the 60 pairs of LCD drivers to the LCD panel. Input the display data in the order of SEG60, SEG59, SEG58, …, SEG2, SEG1.



COM_A, COM_B

In the select mode, a signal in phase with the COM_OUT signal is output at "H" (V_{DD}) and "L" (VLC2).
In the non-select mode a voltage is output at "M" (V_{LC1}). In the select mode of COM_A (non-select mode of COM_B), signals that correspond to the 1st-to 60th-bit data of the data latch are output to the segment outputs.
In the select mode of COM_B (non-select mode of COM_A), signals that correspond to the 61st- to 120th-bit data of the data latch are output to the segment outputs.



SEGn Truth Table

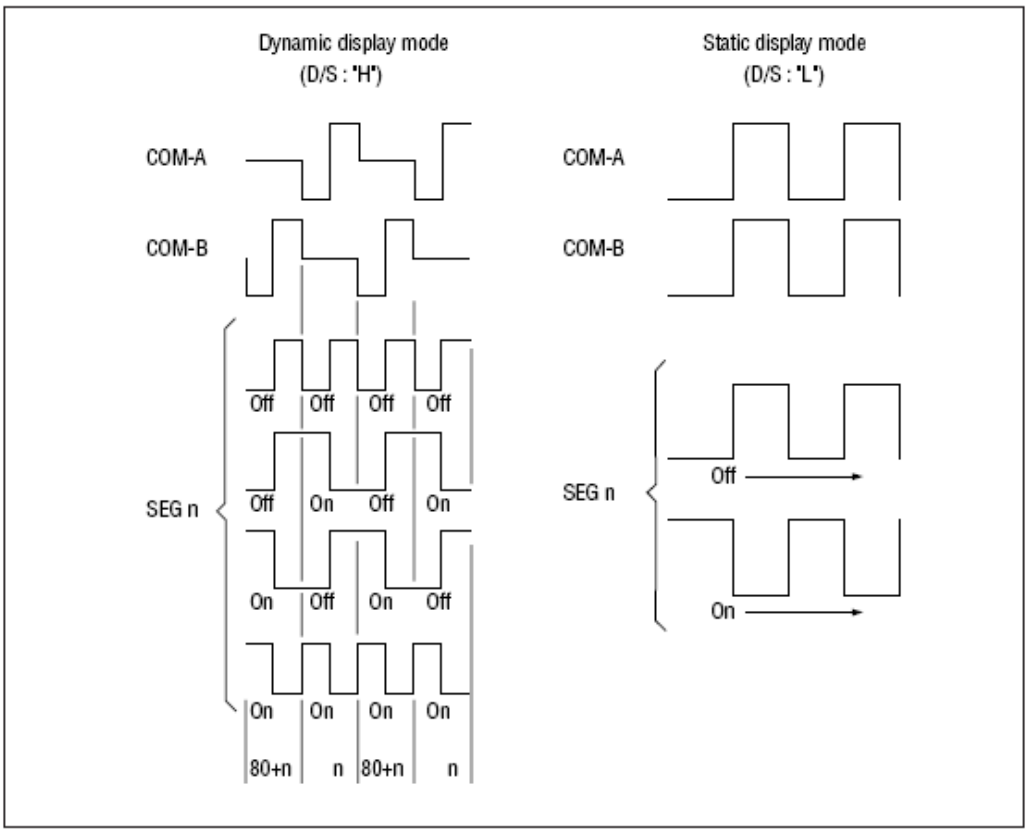
Mode	Display data in LatchA	Display data in LatchB	COMA	COMB	SEGn
Static	1	—	"H"	"H"	0
		—	"L"	"L"	1
	0	—	"H"	"H"	1
		—	"L"	"L"	0
1/2 duty Dynamic	1	1	"H"	"M"	0
			"L"	"M"	1
			"M"	"H"	0
			"M"	"L"	1
	1	0	"H"	"M"	0
			"L"	"M"	1
			"M"	"H"	1
			"M"	"L"	0
	0	1	"H"	"M"	1
			"L"	"M"	0
			"M"	"H"	0
			"M"	"L"	1
	0	0	"H"	"M"	1
			"L"	"M"	0
			"M"	"H"	1
			"M"	"L"	0

*Note: "H" = V_{DD}; "M" = V_{LC1}; "L" = V_{LC2}.

SEG1-SEG60
LCD segmnet driving signals are outputfrom these pins and they should be connected to the segment side of the LCD panel.

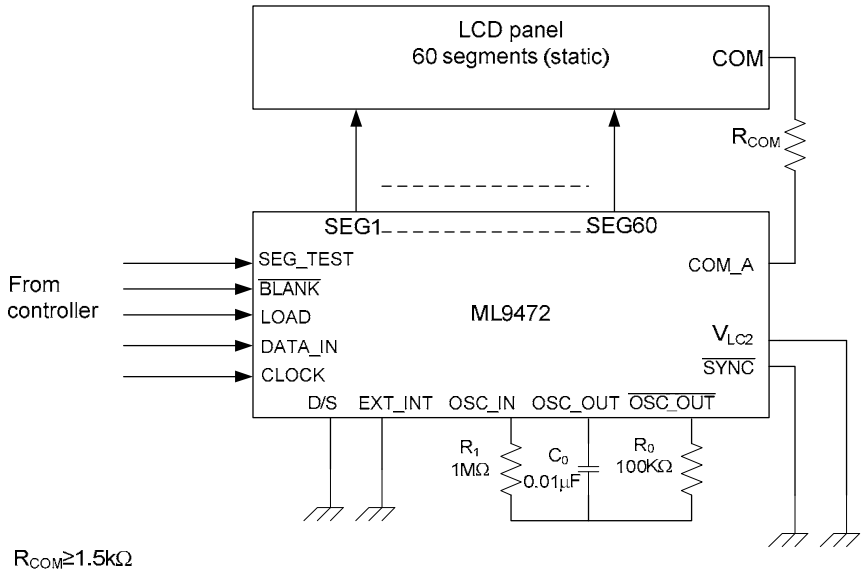
"H" level: V_{DD}, "L" level: V_{LC2}
In the static display mode, the nth bit data of the data latch (A) corresponds to the SEGn. The data of the data latch (B) is invalid.
A signal out of phase with the COM_OUT signal is output to the segment outputs when the display is turned on, while a signal in phase with it is output when the display is turned off.

In the 1/2 duty dynamic mode, the output of the SEGn corresponds to the nth bit data of the data latch (A) when COM_A is in select mode and corresponds to the nth bit data of the data latch (B) when COM_B is in select mode. When the display is turned on, a signal out of phase with the common signal corresponding to the data is output, while a signal in phase with the common signal is output when the display is turned off.

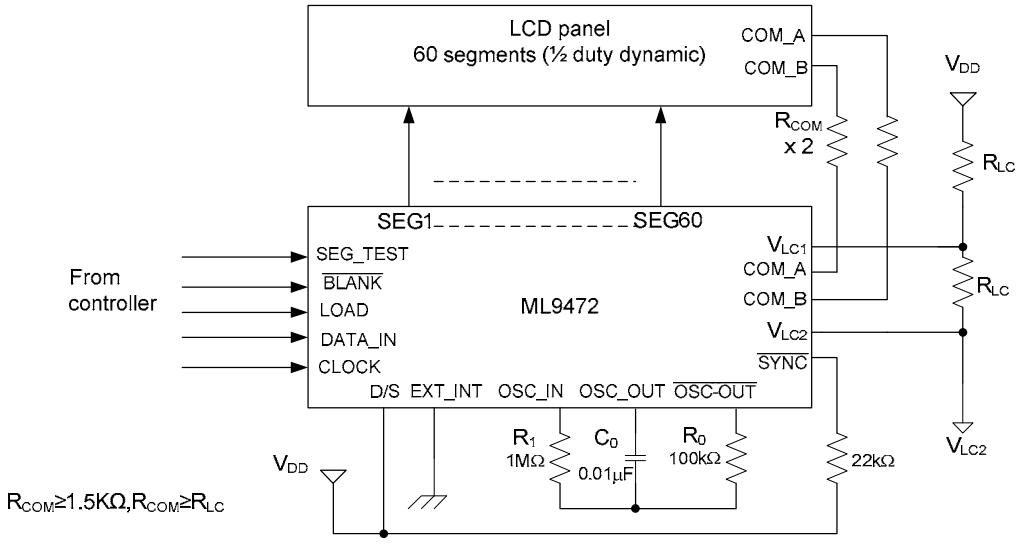


APPLICATION CIRCUITS

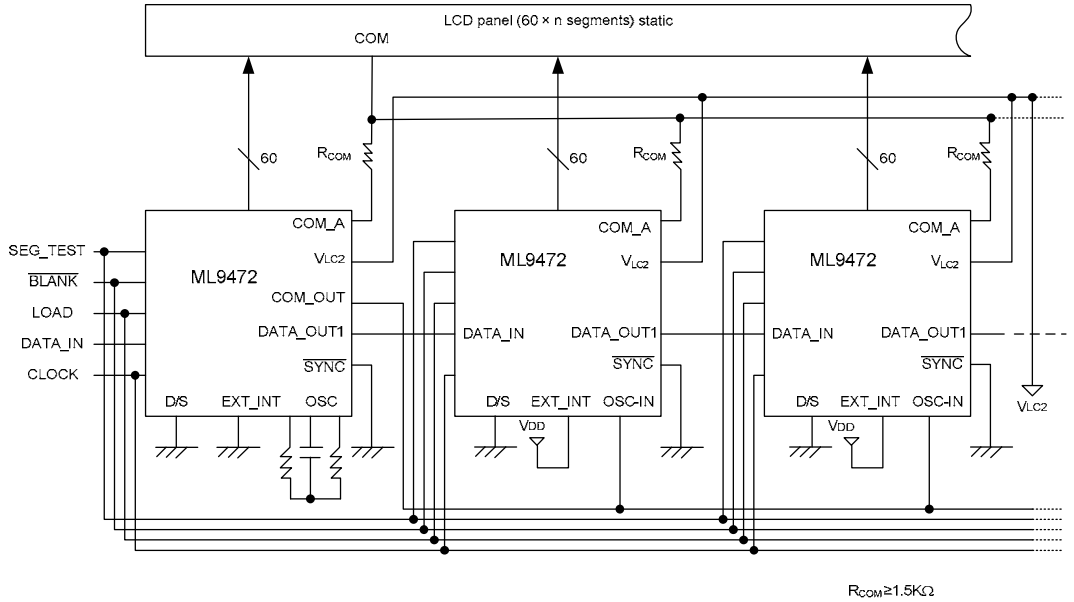
1) Single ML9472 operation in the static display mode



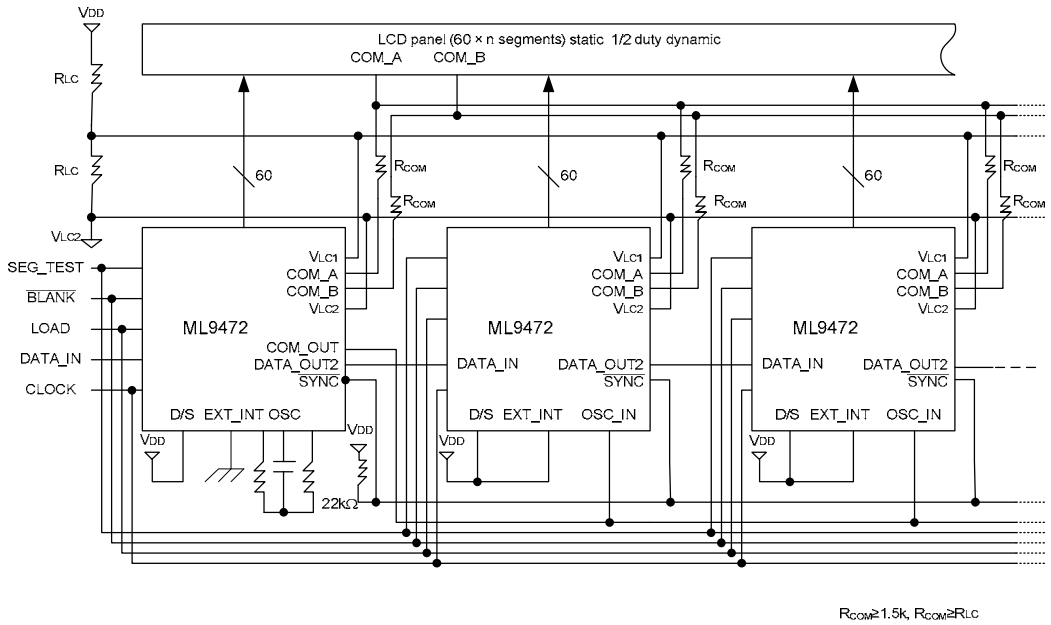
2) Single ML9472 operation in the 1/2 duty dynamic display mode



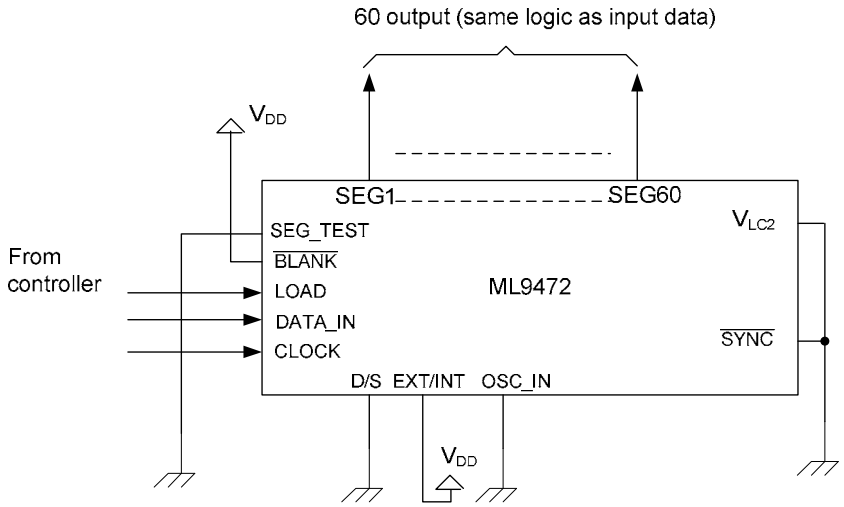
3) Cascade connections for ML9472s in the static display mode



4) Cascade connections for ML9472s in the 1/2 duty dynamic display mode



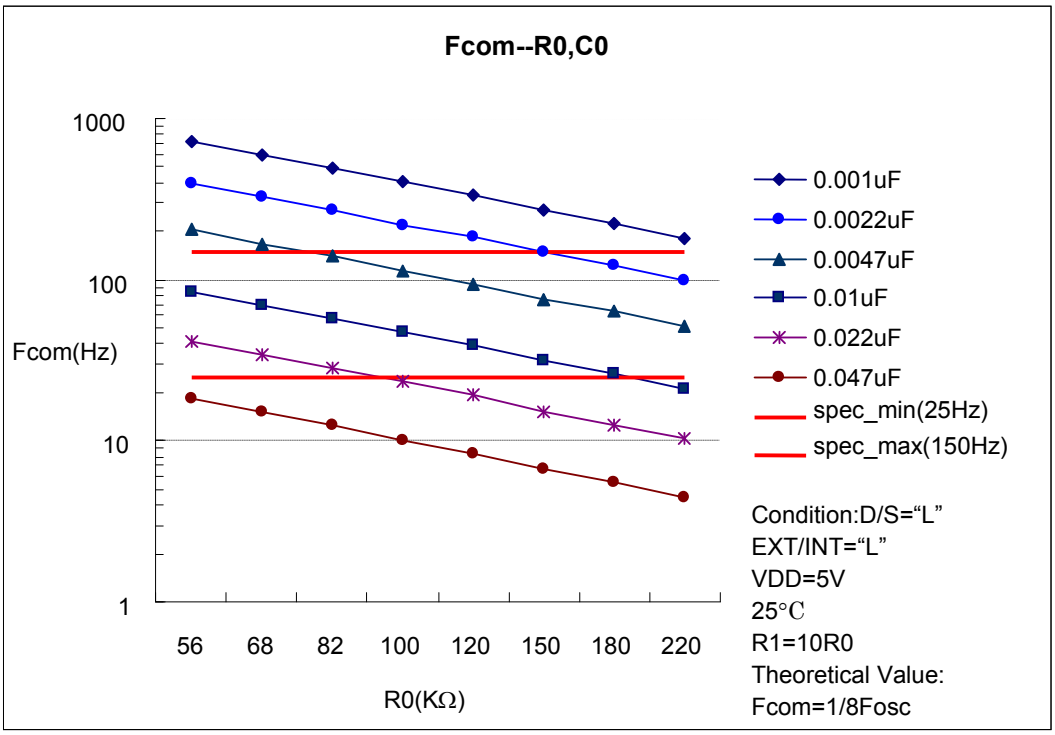
5) Output-expander



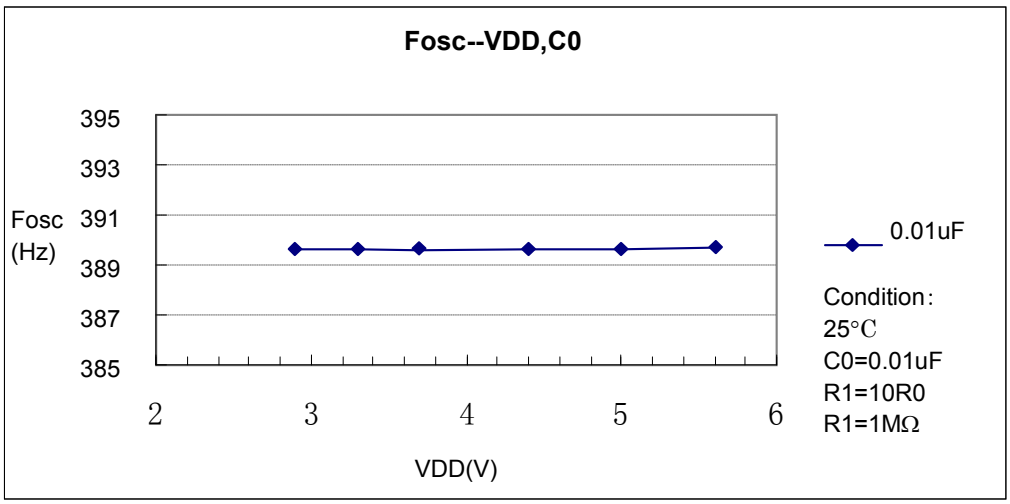
*The output logic can be reversed with respect to the input data by setting OSC_IN to “H” level.

REFERENCE CHARACTERISTICS

·Fcom — R0,C0



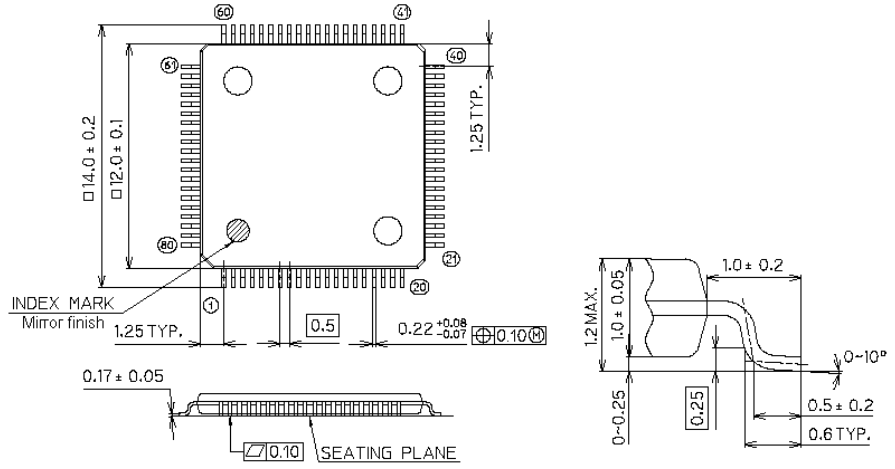
·Fosc — VDD,C0



PACKAGE DIMENSIONS

(Unit: mm)

TQFP80-P-1212-0.50-K



Package material	Epoxy resin
Lead frame material	42 alloy
Pin treatment	Solder plating (≥5µm)
Package weight (g)	0.40 TYP.
Rev. No./Last Revised	4/Oct. 28, 1996

LAPIS Semiconductor Co.,Ltd.

Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact ROHM's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

REVISION HISTORY

Document No.	Date	Page		Description
		Previous Edition	Current Edition	
FEDL9472-01	July. 2, 2007	–	–	Final edition 1
FEDL9472-02	Feb. 1,2008	2	2	BLOCK DIAGRAM
		6	6	Power Dissipation 794mW→650mW
		7	7	Segment Output Impedance Condition Common Output Impedance Condition
		9	9	POWER-ON/OFF TIMING
		10	10	SEGn Truth Table
		14	14	Output-expander
		–	15	Reference Characteristics

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